Product data sheet

1. General description

High power density, hyperfast switching time recovery rectifier with high-efficiency planar technology, encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

Reverse voltage: V_R ≤ 200 V

Forward current: I_F ≤ 4 A

Switching time: t_{rr} ≤ 30 ns

Pt doped life time control

Low inductance

Power and flat lead SMD plastic package

Package height typical 0.95 mm

High power capability due to clip-bond technology

· Planar die design

Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- · General-purpose rectification
- · Reverse polarity protection
- Hyperfast switching
- Freewheeling applications
- Engine Control Unit (ECU)

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 173 °C		-	-	4	А
V_R	reverse voltage	T _j = 25 °C		-	-	200	V
V_{RRM}	repetitive peak reverse voltage			-	-	200	V
V _F	forward voltage	I _F = 4 A; T _j = 25 °C	[1]	-	860	930	mV
		I _F = 4 A; T _j = 125 °C	[1]	-	710	780	mV
I _R	reverse current	V _R = 200 V; T _j = 25 °C	[1]	-	-	1	μΑ
		V _R = 200 V; T _j = 125 °C	[1]	-	1.5	10	μΑ

^[1] Very short pulse, in order to maintain a stable junction temperature.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1	5.	
2	A2	anode 2	3	K A1
3	K	cathode]2	A2 aaa-033688
			CFP15B (SOT1289B)	

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
PNE20040EPE-Q		plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	SOT1289B		

7. Marking

Table 4. Marking codes

Type number	Marking code
PNE20040EPE-Q	200E
	104E

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC60134)

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	200	V
V_{RRM}	repetitive peak reverse voltage			-	200	V
V _{R(RMS)lim}	limiting RMS reverse voltage			-	140	V
I _F	forward current	δ = 1; T _{sp} ≤ 150 °C		-	5.6	А
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 173 °C		-	4	А
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; single half sine wave (applied at rated load condition); $T_{j(init)}$ = 25 °C		-	130	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	1.75	W
			[2]	-	2.15	W
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint. Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 $\rm cm^2$.

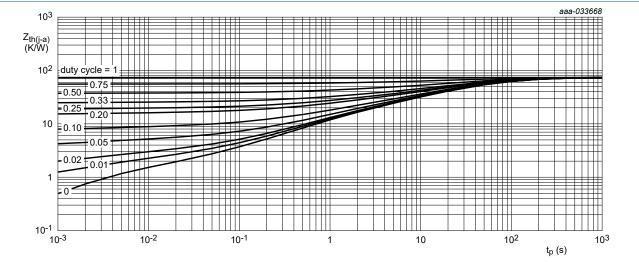
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9. Thermal characteristics

Table 6. Thermal characteristics

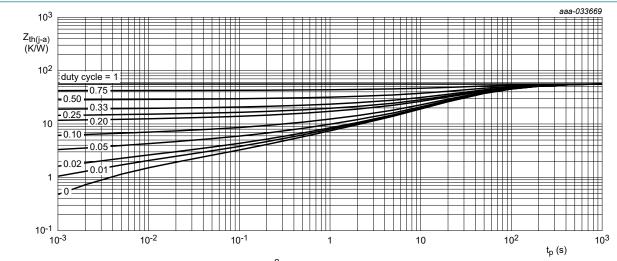
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from	in free air	[1]	-	-	85	K/W
junction to ambient		[2]	-	-	70	K/W	
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	1.2	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [3] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm²

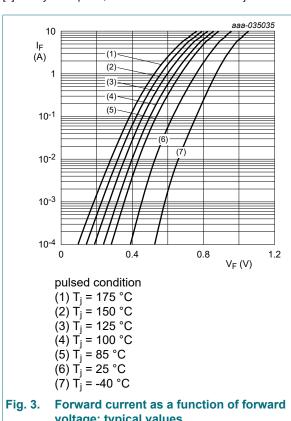
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I _R = 100 μA; T _j = 25 °C	[1]	200	-	-	V
V _F	forward voltage	I _F = 4 A; T _j = 25 °C	[1]	-	860	930	mV
		I _F = 4 A; T _j = 125 °C	[1]	-	710	780	mV
I _R	reverse current	V _R = 200 V; T _j = 25 °C	[1]	-	-	1	μΑ
		V _R = 200 V; T _j = 125 °C	[1]	-	1.5	10	μΑ
C _d	diode capacitance	V _R = 4 V; f = 1 MHz; T _j = 25 °C		-	61	-	pF
t _{rr}	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 1 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_j = 25 \text{ °C}$		-	12	30	ns
	reverse recovery time ramp recovery	$dI_F/dt = 50 \text{ A/}\mu\text{s}; I_F = 1 \text{ A}; V_R = 30 \text{ V};$ $T_j = 25 ^{\circ}\text{C}$		-	18	-	ns
V_{FRM}	peak forward recovery voltage	$I_F = 1 \text{ A}; \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s}; T_j = 25 ^{\circ}\text{C}$		-	830	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.



voltage; typical values

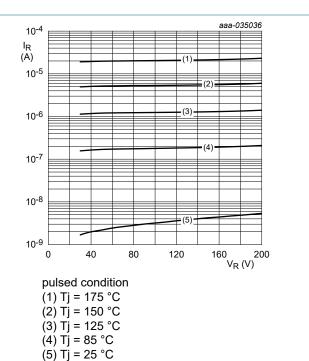


Fig. 4. Reverse current as a function of reverse voltage; typical values

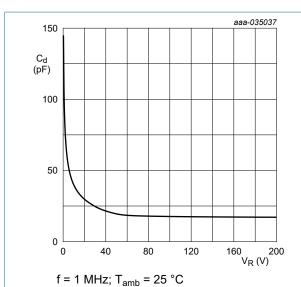
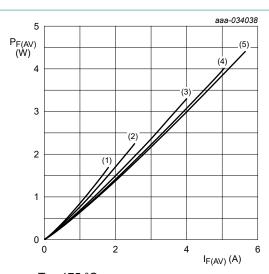


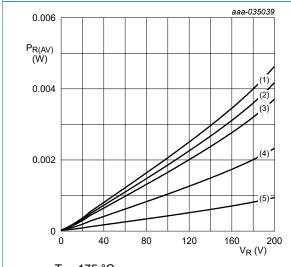
Fig. 5. Diode capacitance as a function of reverse voltage; typical values



 $T_j = 175 \,^{\circ}\text{C}$ (1) $\delta = 0.1$ (2) $\delta = 0.2$ (3) $\delta = 0.5$ (4) $\delta = 0.8$

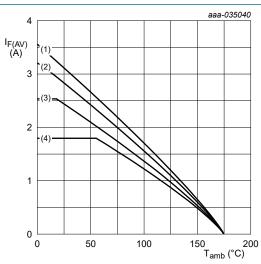
(5) $\delta = 1$; DC

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 175 \,^{\circ}\text{C}$ (1) $\delta = 1$; DC (2) $\delta = 0.9$ (3) $\delta = 0.8$ (4) $\delta = 0.5$ (5) $\delta = 0.2$

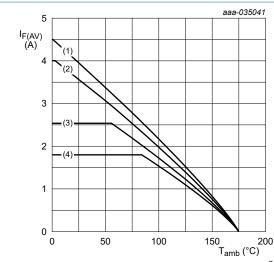
Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

 $T_j = 175$ °C (1) $\delta = 1$; DC (2) $\delta = 0.5$; f = 20 kHz (3) $\delta = 0.2$; f = 20 kHz (4) $\delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

 $T_i = 175 \,{}^{\circ}\text{C}$

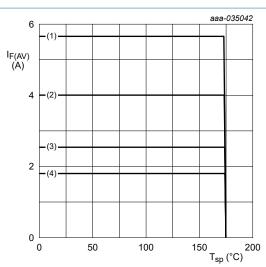
 $(1) \delta = 1$; DC

 $(2) \delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

 $(4) \delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



T_i = 175 °C

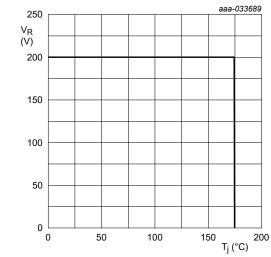
 $(1) \delta = 1; DC$

(2) δ = 0.5; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

 $(4) \delta = 0.1$; f = 20 kHz

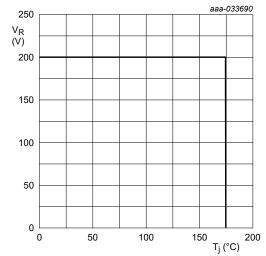
Fig. 10. Average forward current as a function of solder point temperature; typical values



FR4 PCB, standard footprint

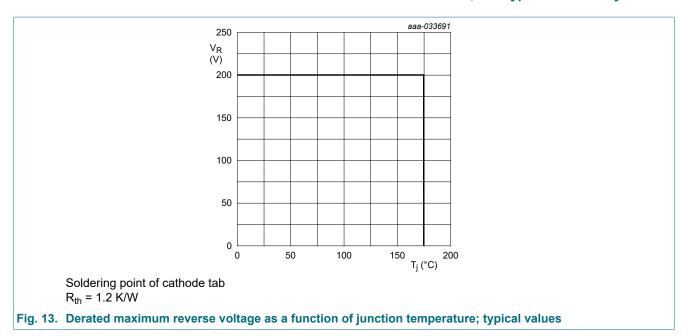
 $R_{th} = 85 \text{ K/W}$



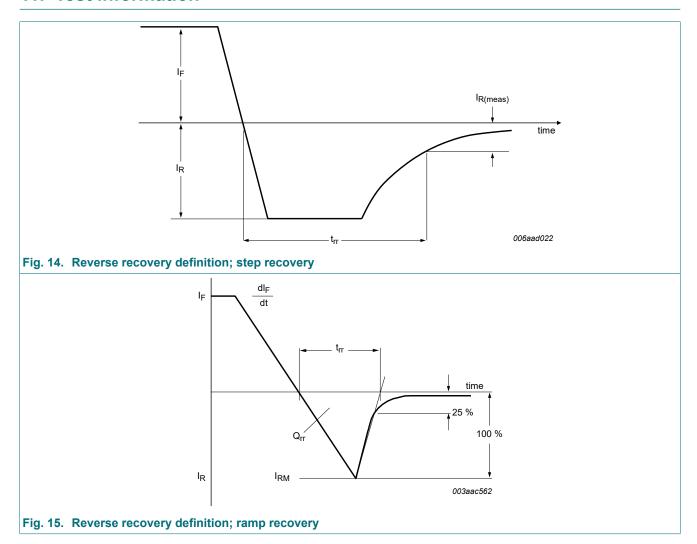


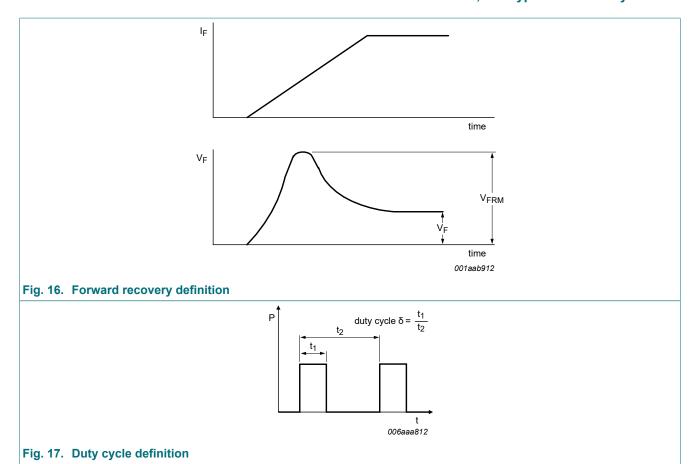
FR4 PCB, mounting pad for cathode 1 cm² $R_{th} = 70 \text{ K/W}$

of junction temperature; typical values



11. Test information





The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_{M} \times \sqrt{\delta}$

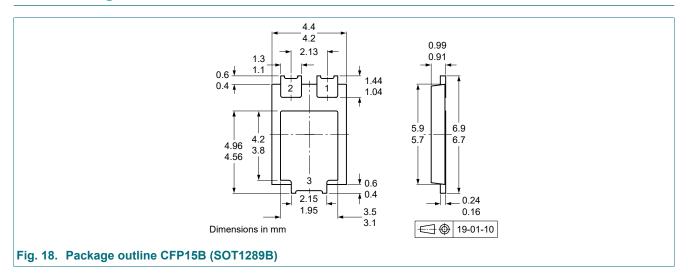
with $I_{\mbox{\scriptsize RMS}}$ defined as RMS current.

Quality information

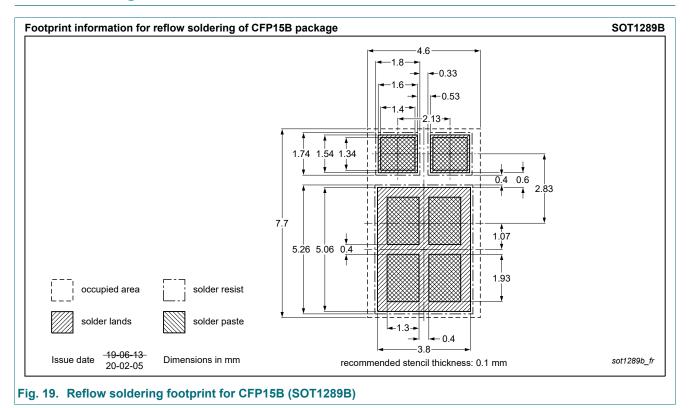
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history

Table of Revieren Initial				
Data sheet ID	Release date		Change notice	Supersedes
PNE20040EPE-Q v.1	20220616	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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